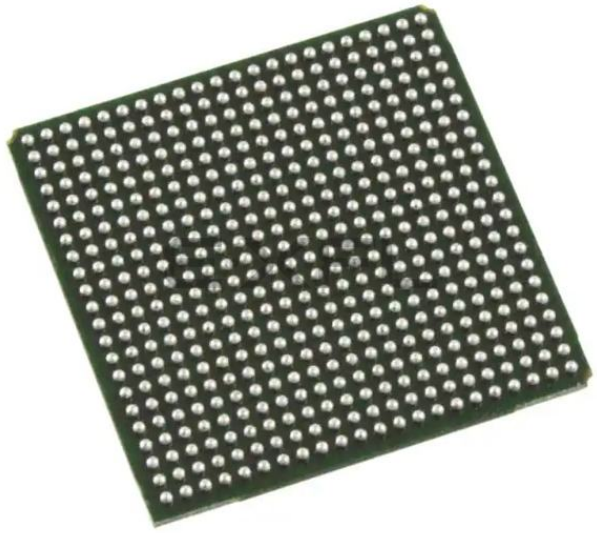
Lattice Semiconductor Corporation - LFE2-20SE-6FN484I Datasheet



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Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	331
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20se-6fn484i

LatticeECP2/M Family Data Sheet Introduction

July 2012 Data Sheet DS1006

Features

- **High Logic Density for System Integration**
  - 6K to 95K LUTs
  - 90 to 583 I/Os
- **Embedded SERDES (LatticeECP2M Only)**
  - Data Rates 250 Mbps to 3.125 Gbps
  - Up to 16 channels per device
    PCI Express, Ethernet (1GbE, SGMII), OBSAI, CPRI and Serial RapidIO.
- **sysDSP™ Block**
  - 3 to 42 blocks for high performance multiply and accumulate
  - Each block supports
    - One 36x36, four 18x18 or eight 9x9 multipliers
- **Flexible Memory Resources**
  - 55Kbits to 5308Kbits sysMEM™ Embedded Block RAM (EBR)
    - 18Kbit block
    - Single, pseudo dual and true dual port
    - Byte Enable Mode support
  - 12K to 202Kbits distributed RAM
    - Single port and pseudo dual port
- **sysCLOCK Analog PLLs and DLLs**
  - Two GPLLs and up to six SPLLs per device
    - Clock multiply, divide, phase & delay adjust
    - Dynamic PLL adjustment
  - Two general purpose DLLs per device
- **Pre-Engineered Source Synchronous I/O**
  - DDR registers in I/O cells
  - Dedicated gearing logic
  - Source synchronous standards support
    - SPI4.2, SFI4 (DDR Mode), XGMII
    - High Speed ADC/DAC devices
  - Dedicated DDR and DDR2 memory support
    - DDR1: 400 (200MHz) / DDR2: 533 (266MHz)
  - Dedicated DQS support
- **Programmable sysI/O™ Buffer Supports Wide Range Of Interfaces**
  - LVTTL and LVCMOS 33/25/18/15/12
  - SSTL 3/2/18 I, II
  - HSTL15 I and HSTL18 I, II
  - PCI and Differential HSTL, SSTL
  - LVDS, RSDS, Bus-LVDS, MLVDS, LVPECL
- **Flexible Device Configuration**
  - 1149.1 Boundary Scan compliant
  - Dedicated bank for configuration I/Os
  - SPI boot flash interface
  - Dual boot images supported
  - TransFR™ I/O for simple field updates
  - Soft Error Detect macro embedded
- **Optional Bitstream Encryption (LatticeECP2/M "S" Versions Only)**
- **System Level Support**
  - ispTRACY™ internal logic analyzer capability
  - On-chip oscillator for initialization & general use
  - 1.2V power supply

Table 1-1. LatticeECP2 (Including "S-Series") Family Selection

Device	ECP2-6	ECP2-12	ECP2-20	ECP2-35	ECP2-50	ECP2-70
LUTs (K)	6	12	21	32	48	68
Distributed RAM (Kbits)	12	24	42	64	96	136
EBR SRAM (Kbits)	55	221	276	332	387	1032
EBR SRAM Blocks	3	12	15	18	21	60
sysDSP Blocks	3	6	7	8	18	22
18x18 Multipliers	12	24	28	32	72	88
GPLL + SPLL + DLL	2+0+2	2+0+2	2+0+2	2+0+2	2+2+2	2+4+2
Maximum Available I/O	190	297	402	450	500	583
Packages and I/O Combinations						
144-pin TQFP (20 x 20 mm)	90	93				
208-pin PQFP (28 x 28 mm)		131	131			
256-ball fpBGA (17 x 17 mm)	190	193	193			
484-ball fpBGA (23 x 23 mm)		297	331	331	339	
672-ball fpBGA (27 x 27 mm)			402	450	500	500
900-ball fpBGA (31 x 31 mm)						583

for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm ±1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5[1]	13.0	45.0	2.5[1]
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

LatticeECP2/M External Switching Characteristics[9] (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{HPLL}	Clock to Data Hold - PIO Input Register	LFE2-6	1.00	—	1.20	—	1.40	—	ns
		LFE2-12	1.00	—	1.20	—	1.40	—	ns
		LFE2-20	1.00	—	1.20	—	1.40	—	ns
		LFE2-35	1.00	—	1.20	—	1.40	—	ns
		LFE2-50	1.00	—	1.20	—	1.40	—	ns
		LFE2-70	1.00	—	1.20	—	1.40	—	ns
		LFE2M20	1.00	—	1.20	—	1.40	—	ns
		LFE2M35	1.00	—	1.20	—	1.40	—	ns
		LFE2M50	1.00	—	1.20	—	1.40	—	ns
		LFE2M70	1.00	—	1.20	—	1.40	—	ns
		LFE2M100	1.00	—	1.20	—	1.40	—	ns
t_{SU_DELPLL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.80	—	2.00	—	2.20	—	ns
		LFE2-12	1.80	—	2.00	—	2.20	—	ns
		LFE2-20	1.80	—	2.00	—	2.20	—	ns
		LFE2-35	1.80	—	2.00	—	2.20	—	ns
		LFE2-50	1.80	—	2.00	—	2.20	—	ns
		LFE2-70	1.80	—	2.00	—	2.20	—	ns
		LFE2M20	1.80	—	2.00	—	2.20	—	ns
		LFE2M35	1.80	—	2.00	—	2.20	—	ns
		LFE2M50	1.90	—	2.10	—	2.30	—	ns
		LFE2M70	1.90	—	2.10	—	2.30	—	ns
		LFE2M100	2.00	—	2.20	—	2.40	—	ns
t_{H_DELPLL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
DDR I/O Pin Parameters[2]									
t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR}	DDR Clock Frequency[6]	ECP2/M	95	200	95	166	95	133	MHz
DDR2 I/O Pin Parameters[3]									
t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI

LatticeECP2/M Family Timing Adders[1, 2, 3] (Continued)

Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
LVCMOS25_4mA	LVCMOS 2.5 4mA drive, slow slew rate	2.18	2.26	2.33	ns
LVCMOS25_8mA	LVCMOS 2.5 8mA drive, slow slew rate	2.19	2.35	2.51	ns
LVCMOS25_12mA	LVCMOS 2.5 12mA drive, slow slew rate	1.50	1.66	1.82	ns
LVCMOS25_16mA	LVCMOS 2.5 16mA drive, slow slew rate	1.60	1.59	1.58	ns
LVCMOS25_20mA	LVCMOS 2.5 20mA drive, slow slew rate	1.43	1.39	1.34	ns
LVCMOS18_4mA	LVCMOS 1.8 4mA drive, slow slew rate	2.22	2.27	2.32	ns
LVCMOS18_8mA	LVCMOS 1.8 8mA drive, slow slew rate	1.93	2.08	2.23	ns
LVCMOS18_12mA	LVCMOS 1.8 12mA drive, slow slew rate	1.43	1.51	1.58	ns
LVCMOS18_16mA	LVCMOS 1.8 16mA drive, slow slew rate	1.47	1.46	1.45	ns
LVCMOS15_4mA	LVCMOS 1.5 4mA drive, slow slew rate	2.32	2.38	2.43	ns
LVCMOS15_8mA	LVCMOS 1.5 8mA drive, slow slew rate	1.84	1.98	2.12	ns
LVCMOS12_2mA	LVCMOS 1.2 2mA drive, slow slew rate	2.52	2.63	2.74	ns
LVCMOS12_6mA	LVCMOS 1.2 6mA drive, slow slew rate	1.69	1.83	1.96	ns
PCI33	PCI33	0.04	0.04	0.04	ns

1. Timing Adders are characterized but not tested on every device.
2. LVCMOS timing measured with the load specified in Switching Test Condition table.
3. All other standards tested according to the appropriate specifications.
4. These timing adders are measured with the recommended resistor values.

Timing v.A 0.11

SERDES High-Speed Data Transmitter (LatticeECP2M Family Only)[1, 2]

Table 3-7. Serial Output Timing and Levels

Symbol	Description	Frequency	Min.	Typ.	Max.	Units
$V_{TX-DIFF-P-P-1}$	Differential swing (1V setting)[1, 2]	0.25 to 3.125 Gbps	0.79	0.99	1.19	V, p-p
$V_{TX-DIFF-P-P-1.25}$	Differential swing (1.25V setting)[1, 2]	0.25 to 3.125 Gbps	1.00	1.25	1.50	V, p-p
$V_{TX-DIFF-P-P-1.3}$	Differential swing (1.3V setting)[1, 2]	0.25 to 3.125 Gbps	1.04	1.30	1.56	V, p-p
$V_{TX-DIFF-P-P-1.35}$	Differential swing (1.35V setting)[1, 2]	0.25 to 3.125 Gbps	1.08	1.35	1.62	V, p-p
V_{OCM}	Output common mode voltage	—	V_{CCOB} - 0.75	V_{CCOB} - 0.60	V_{CCOB} - 0.45	V
T_{TX-R}	Rise time (20% to 80%)	—	—	70	—	ps
T_{TX-F}	Fall time (80% to 20%)	—	—	70	—	ps
$Z_{TX-OI-SE}$	Output impedance 50/75/HiZ K Ohms (single-ended)	—	—	50/70 HiZ	—	Ohms
R_{TX-RL}	Return loss (with package)	—	—	9	—	dB

1. All measurements are with 50 ohm impedance.
2. See TN1124, LatticeECP2M SERDES/PCS Usage Guide for actual binary settings.

Table 3-8. Channel Output Jitter - x10 Mode

Description	Frequency	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	—	0.08	0.12	UI, p-p
Random	3.125 Gbps	—	0.22	0.38	UI, p-p
Total	3.125 Gbps	—	0.33	0.43	UI, p-p
Deterministic	2.5 Gbps	—	0.08	0.17	UI, p-p
Random	2.5 Gbps	—	0.20	0.25	UI, p-p
Total	2.5 Gbps	—	0.25	0.35	UI, p-p
Deterministic	1.25 Gbps	—	0.03	0.10	UI, p-p
Random	1.25 Gbps	—	0.14	0.19	UI, p-p
Total	1.25 Gbps	—	0.17	0.24	UI, p-p
Deterministic	250 Mbps	—	0.04	0.17	UI, p-p
Random	250 Mbps	—	0.12	0.13	UI, p-p
Total	250 Mbps	—	0.15	0.29	UI, p-p

Note: Values are measured with PRBS 2^7-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x10 mode.

PICs and DDR Data (DQ) Pins Associated with the DDR Strobe (DQS) Pin

PICs Associated with DQS Strobe	PIO Within PIC	DDR Strobe (DQS) and Data (DQ) Pins
For Left and Right Edges of the Device		
P[Edge] [n-4]	A	DQ
	B	DQ
P[Edge] [n-3]	A	DQ
	B	DQ
P[Edge] [n-2]	A	DQ
	B	DQ
P[Edge] [n-1]	A	DQ
	B	DQ
P[Edge] [n]	A	[Edge]DQSn
	B	DQ
P[Edge] [n+1]	A	DQ
	B	DQ
P[Edge] [n+2]	A	DQ
	B	DQ
P[Edge] [n+3]	A	DQ
	B	DQ
For Bottom Edge of the Device		
P[Edge] [n-4]	A	DQ
	B	DQ
P[Edge] [n-3]	A	DQ
	B	DQ
P[Edge] [n-2]	A	DQ
	B	DQ
P[Edge] [n-1]	A	DQ
	B	DQ
P[Edge] [n]	A	[Edge]DQSn
	B	DQ
P[Edge] [n+1]	A	DQ
	B	DQ
P[Edge] [n+2]	A	DQ
	B	DQ
P[Edge] [n+3]	A	DQ
	B	DQ
P[Edge] [n+4]	A	DQ
	B	DQ

Notes:
1. “n” is a row PIC number.
2. The DDR interface is designed for memories that support one DQS strobe up to 15 bits of data for the left and right edges and up to 17 bits of data for the bottom edge. In some packages, all the potential DDR data (DQ) pins may not be available. PIC numbering definitions are provided in the “Signal Names” column of the Signal Descriptions table.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO6	-			GNDIO6	-		
L2	PL24A	6	LDQ28	T (LVDS)*	PL24A	6	LDQ28	T (LVDS)*
K2	PL25A	6	LDQ28	T	PL25A	6	LDQ28	T
L3	PL24B	6	LDQ28	C (LVDS)*	PL24B	6	LDQ28	C (LVDS)*
K1	PL25B	6	LDQ28	C	PL25B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
L4	PL26A	6	LDQ28	T (LVDS)*	PL26A	6	LDQ28	T (LVDS)*
L1	PL27A	6	LDQ28	T	PL27A	6	LDQ28	T
L5	PL26B	6	LDQ28	C (LVDS)*	PL26B	6	LDQ28	C (LVDS)*
M1	PL27B	6	LDQ28	C	PL27B	6	LDQ28	C
GND	GNDIO6	-			GNDIO6	-		
N1	PL29A	6	LDQ28	T	PL29A	6	LDQ28	T
N2	PL28A	6	LDQS28	T (LVDS)*	PL28A	6	LDQS28	T (LVDS)*
P1	PL29B	6	LDQ28	C	PL29B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
P2	PL28B	6	LDQ28	C (LVDS)*	PL28B	6	LDQ28	C (LVDS)*
R1	PL30A	6	LDQ28	T (LVDS)*	PL30A	6	LDQ28	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
R2	PL30B	6	LDQ28	C (LVDS)*	PL30B	6	LDQ28	C (LVDS)*
N4	TDI	-			TDI	-		
M4	TCK	-			TCK	-		
P3	TDO	-			TDO	-		
N3	TMS	-			TMS	-		
K7	VCCJ	-			VCCJ	-		
M5	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
K6	NC	-			PB3A	5	BDQ6	
M6	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
R3	NC	-			PB5A	5	BDQ6	T
P4	NC	-			PB5B	5	BDQ6	C
-	-	-			VCCIO	5		
-	-	-			GNDIO5	5		
N5	PB3A	5	BDQ6	T	PB21A	5	BDQ24	T
N6	PB3B	5	BDQ6	C	PB21B	5	BDQ24	C
T2	PB4A	5	BDQ6	T	PB22A	5	BDQ24	T
P6	PB5A	5	BDQ6	T	PB23A	5	BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		
T3	PB4B	5	BDQ6	C	PB22B	5	BDQ24	C
R6	PB5B	5	BDQ6	C	PB23B	5	BDQ24	C
GND	GNDIO5	-			GNDIO5	-		
R4	PB6A	5	BDQS6	T	PB24A	5	BDQS24	T
L6	PB7A	5	BDQ6	T	PB25A	5	BDQ24	T
T4	PB6B	5	BDQ6	C	PB24B	5	BDQ24	C
L7	PB7B	5	BDQ6	C	PB25B	5	BDQ24	C
N7	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N14	CFG1	8			CFG1	8		
N13	PROGRAMN	8			PROGRAMN	8		
N15	CFG0	8			CFG0	8		
P15	PR30B	8	WRITEN	C	PR30B	8	WRITEN	C
L12	INITN	8			INITN	8		
N16	PR29B	8	CSN	C	PR29B	8	CSN	C
GND	GNDIO8	-			GNDIO8	-		
R14	CCLK	8			CCLK	8		
P14	PR30A	8	CS1N	T	PR30A	8	CS1N	T
M13	DONE	8			DONE	8		
R16	PR28B	8	D1	C	PR28B	8	D1	C
VCCIO	VCCIO8	8			VCCIO8	8		
M16	PR29A	8	D0/SPIFASTN	T	PR29A	8	D0/SPIFASTN	T
P16	PR28A	8	D2	T	PR28A	8	D2	T
L15	PR27B	8	D3	C	PR27B	8	D3	C
GND	GNDIO8	-			GNDIO8	-		
L14	PR26A	8	D6	T	PR26A	8	D6	T
L16	PR27A	8	D4	T	PR27A	8	D4	T
L10	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
L13	PR26B	8	D5	C	PR26B	8	D5	C
VCCIO	VCCIO8	8			VCCIO8	8		
K11	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
K14	PR24B	8	DOUT/CSON	C	PR24B	8	DOUT/CSON	C
K13	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
GND	GNDIO8	-			GNDIO8	-		
K15	PR21B	3	RLM0_GPLLC_FB_A	C	PR21B	3	RLM0_GPLLC_FB_A	C
VCCIO	VCCIO3	3			VCCIO3	3		
K16	PR21A	3	RLM0_GPLLT_FB_A	T	PR21A	3	RLM0_GPLLT_FB_A	T
GND	GNDIO3	-			GNDIO3	-		
J16	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*
J15	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*
J14	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
J13	PR18B	3	RLM0_GDLLC_FB_A	C	PR18B	3	RLM0_GDLLC_FB_A	C
J12	PR18A	3	RLM0_GDLLT_FB_A	T	PR18A	3	RLM0_GDLLT_FB_A	T
H12	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
H13	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*
H15	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C
VCCIO	VCCIO3	3			VCCIO3	3		
H16	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T
H11	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*
J11	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*
G16	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C
GND	GNDIO2	-			GNDIO2	-		
G15	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D5	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
E5	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T
G7	VCC	-			VCC	-		
G9	VCC	-			VCC	-		
H7	VCC	-			VCC	-		
J10	VCC	-			VCC	-		
K10	VCC	-			VCC	-		
K8	VCC	-			VCC	-		
G8	VCCAUX	-			VCCAUX	-		
H10	VCCAUX	-			VCCAUX	-		
J7	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
C5	VCCIO0	0			VCCIO0	0		
E7	VCCIO0	0			VCCIO0	0		
C12	VCCIO1	1			VCCIO1	1		
E10	VCCIO1	1			VCCIO1	1		
E14	VCCIO2	2			VCCIO2	2		
G12	VCCIO2	2			VCCIO2	2		
K12	VCCIO3	3			VCCIO3	3		
M14	VCCIO3	3			VCCIO3	3		
M10	VCCIO4	4			VCCIO4	4		
P12	VCCIO4	4			VCCIO4	4		
M7	VCCIO5	5			VCCIO5	5		
P5	VCCIO5	5			VCCIO5	5		
K5	VCCIO6	6			VCCIO6	6		
M3	VCCIO6	6			VCCIO6	6		
E3	VCCIO7	7			VCCIO7	7		
G5	VCCIO7	7			VCCIO7	7		
T15	VCCIO8	8			VCCIO8	8		
A1	GND	-			GND	-		
A16	GND	-			GND	-		
B12	GND	-			GND	-		
B5	GND	-			GND	-		
C8	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
J13	J13	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C
J12	J12	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T
H12	H12	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*
GND	GND	GNDIO3	-		
H13	H13	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*
H15	H15	PR22B	3	VREF2_3/RDQ25	C
VCCIO	VCCIO	VCCIO3	3		
H16	H16	PR22A	3	VREF1_3/RDQ25	T
H11	H11	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*
J11	J11	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*
G16	G16	PR19B	2	PCLKC2_0/RDQ16	C
GND	GND	GNDIO2	-		
G15	G15	PR19A	2	PCLKT2_0/RDQ16	T
F15	F15	PR17B	2	RDQ16	C
G11	G11	PR18B	2	RDQ16	C (LVDS)*
F14	F14	PR17A	2	RDQ16	T
VCCIO	VCCIO	VCCIO2	2		
F12	F12	PR18A	2	RDQ16	T (LVDS)*
G14	G14	PR16B	2	RDQ16	C (LVDS)*
G13	G13	PR16A	2	RDQS16	T (LVDS)*
GND	GND	GNDIO2	-		
F16	F16	PR14B	2	RDQ16	C (LVDS)*
F9	F9	PR15B	2	RDQ16	C
E16	E16	PR14A	2	RDQ16	T (LVDS)*
F10	F10	PR15A	2	RDQ16	T
VCCIO	VCCIO	VCCIO2	2		
D16	D16	PR13B	2	RDQ16	C
D15	D15	PR13A	2	RDQ16	T
C15	C15	PR6B	2	RDQ8	C (LVDS)*
C16	C16	PR7B	2	RDQ8	C
GND	GND	GNDIO2	-		
D14	D14	PR6A	2	RDQ8	T (LVDS)*
B16	B16	PR7A	2	RDQ8	T
F13	F13	PR2B	2	VREF2_2	C (LVDS)*
VCCIO	VCCIO	VCCIO2	2		
E13	E13	PR2A	2	VREF1_2	T (LVDS)*
F11	F11	PT64B	1	VREF2_1	C
E11	E11	PT64A	1	VREF1_1	T
GND	GND	GNDIO1	-		
A15	A15	PT63B	1		C
E12	E12	PT62B	1		C
B15	B15	PT63A	1		T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L2	NC	-			NC	-		
L1	NC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
M2	NC	-			NC	-		
M1	NC	-			NC	-		
N2	NC	-			NC	-		
GND	GNDIO7	-			GNDIO7	-		
M8	VCC	-			NC	-		
VCCIO	VCCIO7	7			VCCIO7	7		
GND	GNDIO7	-			GNDIO7	-		
N1	PL12A	7	LDQ16		PL18A	7	LDQ22	
L8	PL13A	7	LDQ16	T	PL19A	7	LDQ22	T
K8	PL13B	7	LDQ16	C	PL19B	7	LDQ22	C
VCCIO	VCCIO7	7			VCCIO7	7		
L6	PL14A	7	LDQ16	T (LVDS)*	PL20A	7	LDQ22	T (LVDS)*
K5	PL14B	7	LDQ16	C (LVDS)*	PL20B	7	LDQ22	C (LVDS)*
L7	PL15A	7	LDQ16	T	PL21A	7	LDQ22	T
L5	PL15B	7	LDQ16	C	PL21B	7	LDQ22	C
GND	GNDIO7	-			GNDIO7	-		
P1	PL16A	7	LDQS16	T (LVDS)*	PL22A	7	LDQS22	T (LVDS)*
P2	PL16B	7	LDQ16	C (LVDS)*	PL22B	7	LDQ22	C (LVDS)*
M6	PL17A	7	LDQ16	T	PL23A	7	LDQ22	T
VCCIO	VCCIO7	7			VCCIO7	7		
N8	PL17B	7	LDQ16	C	PL23B	7	LDQ22	C
R1	PL18A	7	LDQ16	T (LVDS)*	PL24A	7	LDQ22	T (LVDS)*
R2	PL18B	7	LDQ16	C (LVDS)*	PL24B	7	LDQ22	C (LVDS)*
M7	PL19A	7	PCLKT7_0/LDQ16	T	PL25A	7	PCLKT7_0/LDQ22	T
GND	GNDIO7	-			GNDIO7	-		
N9	PL19B	7	PCLKC7_0/LDQ16	C	PL25B	7	PCLKC7_0/LDQ22	C
M4	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	PL27A	6	PCLKT6_0/LDQ31	T (LVDS)*
M5	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	PL27B	6	PCLKC6_0/LDQ31	C (LVDS)*
N7	PL22A	6	VREF2_6/LDQ25	T	PL28A	6	VREF2_6/LDQ31	T
P9	PL22B	6	VREF1_6/LDQ25	C	PL28B	6	VREF1_6/LDQ31	C
N3	PL23A	6	LDQ25	T (LVDS)*	PL29A	6	LDQ31	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
N4	PL23B	6	LDQ25	C (LVDS)*	PL29B	6	LDQ31	C (LVDS)*
N5	PL24A	6	LDQ25	T	PL30A	6	LDQ31	T
P7	PL24B	6	LDQ25	C	PL30B	6	LDQ31	C
T1	NC	-			PL31A	6	LDQS31	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
T2	NC	-			PL31B	6	LDQ31	C (LVDS)*
P8	NC	-			PL32A	6	LDQ31	T
P6	NC	-			PL32B	6	LDQ31	C
VCCIO	VCCIO6	6			VCCIO6	6		
P5	NC	-			PL33A	6	LDQ31	T (LVDS)*
P4	NC	-			PL33B	6	LDQ31	C (LVDS)*

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D4	PT7B	0		C	PT7B	0		C
D3	PT7A	0		T	PT7A	0		T
C2	PT6B	0		C	PT6B	0		C
C1	PT6A	0		T	PT6A	0		T
G8	PT5B	0		C	PT5B	0		C
GND	GNDIO0	-			GNDIO0	-		
G7	PT5A	0		T	PT5A	0		T
E7	PT4B	0		C	PT4B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
F7	PT4A	0		T	PT4A	0		T
E6	PT3B	0		C	PT3B	0		C
E5	PT3A	0		T	PT3A	0		T
G6	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
G5	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T
L12	VCC	-			VCC	-		
L13	VCC	-			VCC	-		
L14	VCC	-			VCC	-		
L15	VCC	-			VCC	-		
M11	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M15	VCC	-			VCC	-		
M16	VCC	-			VCC	-		
N11	VCC	-			VCC	-		
N16	VCC	-			VCC	-		
P11	VCC	-			VCC	-		
P16	VCC	-			VCC	-		
R11	VCC	-			VCC	-		
R12	VCC	-			VCC	-		
R15	VCC	-			VCC	-		
R16	VCC	-			VCC	-		
T12	VCC	-			VCC	-		
T13	VCC	-			VCC	-		
T14	VCC	-			VCC	-		
T15	VCC	-			VCC	-		
D11	VCCIO0	0			VCCIO0	0		
D6	VCCIO0	0			VCCIO0	0		
G9	VCCIO0	0			VCCIO0	0		
K12	VCCIO0	0			VCCIO0	0		
J12	VCCIO0	0			VCCIO0	0		
D16	VCCIO1	1			VCCIO1	1		
D21	VCCIO1	1			VCCIO1	1		
G18	VCCIO1	1			VCCIO1	1		
J15	VCCIO1	1			VCCIO1	1		
K15	VCCIO1	1			VCCIO1	1		
F23	VCCIO2	2			VCCIO2	2		
J20	VCCIO2	2			VCCIO2	2		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
K1	PL27B	7	LDQ29	C (LVDS)*
K5	PL28A	7	LDQ29	T
K7	PL28B	7	LDQ29	C
GND	GNDIO7	-		
K4	PL29A	7	LDQS29	T (LVDS)*
K3	PL29B	7	LDQ29	C (LVDS)*
L8	PL30A	7	LDQ29	T
VCCIO	VCCIO7	7		
L6	PL30B	7	LDQ29	C
L2	PL31A	7	LDQ29	T (LVDS)*
L1	PL31B	7	LDQ29	C (LVDS)*
L7	PL32A	7	LDQ29	T
GND	GNDIO7	-		
L5	PL32B	7	LDQ29	C
L4	PL33A	7	LDQ37	T (LVDS)*
L3	PL33B	7	LDQ37	C (LVDS)*
M8	PL34A	7	LDQ37	T
M6	PL34B	7	LDQ37	C
VCCIO	VCCIO7	7		
M2	PL35A	7	LDQ37	T (LVDS)*
M1	PL35B	7	LDQ37	C (LVDS)*
M7	PL36A	7	LDQ37	T
M5	PL36B	7	LDQ37	C
GND	GNDIO7	-		
M4	PL37A	7	LDQS37	T (LVDS)*
M3	PL37B	7	LDQ37	C (LVDS)*
N6	PL38A	7	LUM0_SPLLT_IN_A/LDQ37	T
VCCIO	VCCIO7	7		
N8	PL38B	7	LUM0_SPLLC_IN_A/LDQ37	C
N5	PL39A	7	LUM0_SPLLT_FB_A/LDQ37	T
N7	PL39B	7	LUM0_SPLLC_FB_A/LDQ37	C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
T9	PL50A	7	LDQ54	
R9	PL51A	7	LDQ54	T
P7	PL51B	7	LDQ54	C
VCCIO	VCCIO7	7		
N2	PL52A	7	LDQ54	T (LVDS)*
N1	PL52B	7	LDQ54	C (LVDS)*
P6	PL53A	7	LDQ54	T
P5	PL53B	7	LDQ54	C
GND	GNDIO7	-		
P4	PL54A	7	LDQS54	T (LVDS)*

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
G18	VCCIO2	2			VCCIO2	2		
J15	VCCIO2	2			VCCIO2	2		
K19	VCCIO2	2			VCCIO2	2		
N19	VCCIO3	3			VCCIO3	3		
P15	VCCIO3	3			VCCIO3	3		
T18	VCCIO3	3			VCCIO3	3		
V21	VCCIO3	3			VCCIO3	3		
AA18	VCCIO4	4			VCCIO4	4		
R14	VCCIO4	4			VCCIO4	4		
V16	VCCIO4	4			VCCIO4	4		
W13	VCCIO4	4			VCCIO4	4		
AA5	VCCIO5	5			VCCIO5	5		
R9	VCCIO5	5			VCCIO5	5		
V7	VCCIO5	5			VCCIO5	5		
W10	VCCIO5	5			VCCIO5	5		
N4	VCCIO6	6			VCCIO6	6		
P8	VCCIO6	6			VCCIO6	6		
T5	VCCIO6	6			VCCIO6	6		
V2	VCCIO6	6			VCCIO6	6		
E2	VCCIO7	7			VCCIO7	7		
G5	VCCIO7	7			VCCIO7	7		
J8	VCCIO7	7			VCCIO7	7		
K4	VCCIO7	7			VCCIO7	7		
AA22	VCCIO8	8			VCCIO8	8		
U19	VCCIO8	8			VCCIO8	8		
H11	VCCAUX	-			VCCAUX	-		
H12	VCCAUX	-			VCCAUX	-		
L15	VCCAUX	-			VCCAUX	-		
L8	VCCAUX	-			VCCAUX	-		
M15	VCCAUX	-			VCCAUX	-		
M8	VCCAUX	-			VCCAUX	-		
R11	VCCAUX	-			VCCAUX	-		
R12	VCCAUX	-			VCCAUX	-		
A1	GND	-			GND	-		
A10	GND	-			GND	-		
A16	GND	-			GND	-		
A22	GND	-			GND	-		
AA19	GND	-			GND	-		
AA4	GND	-			GND	-		
AB1	GND	-			GND	-		
AB22	GND	-			GND	-		
B13	GND	-			GND	-		
B19	GND	-			GND	-		
B4	GND	-			GND	-		
D16	GND	-			GND	-		
D2	GND	-			GND	-		
D21	GND	-			GND	-		
D7	GND	-			GND	-		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F11	VCCIO0	0			VCCIO0	0		
J13	VCCIO0	0			VCCIO0	0		
K12	VCCIO0	0			VCCIO0	1		
D18	VCCIO1	1			VCCIO1	1		
F16	VCCIO1	1			VCCIO1	1		
J14	VCCIO1	1			VCCIO1	1		
K15	VCCIO1	1			VCCIO1	1		
G25	VCCIO2	2			VCCIO2	2		
L21	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M25	VCCIO2	2			VCCIO2	2		
N18	VCCIO2	2			VCCIO2	2		
P18	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R25	VCCIO3	3			VCCIO3	3		
T21	VCCIO3	3			VCCIO3	3		
Y25	VCCIO3	3			VCCIO3	3		
AA16	VCCIO4	4			VCCIO4	4		
AC18	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V14	VCCIO4	4			VCCIO4	4		
AA11	VCCIO5	5			VCCIO5	5		
V13	VCCIO5	5			VCCIO5	5		
AE12	VCCIO5	5			VCCIO5	5		
AE7	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
P9	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R2	VCCIO6	6			VCCIO6	6		
T6	VCCIO6	6			VCCIO6	6		
Y2	VCCIO6	6			VCCIO6	6		
G2	VCCIO7	7			VCCIO7	7		
L6	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M2	VCCIO7	7			VCCIO7	7		
N9	VCCIO7	7			VCCIO7	7		
AC24	VCCIO8	8			VCCIO8	8		
U17	VCCIO8	8			VCCIO8	8		
J11	VCCAUX	-			VCCAUX	-		
J12	VCCAUX	-			VCCAUX	-		
J15	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
M18	VCCAUX	-			VCCAUX	-		
M9	VCCAUX	-			VCCAUX	-		
R18	VCCAUX	-			VCCAUX	-		
R9	VCCAUX	-			VCCAUX	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
P31	NC	-			PR39B	2		C (LVDS)*
P32	NC	-			PR39A	2		T (LVDS)*
R25	NC	-			PR38B	2		C
-	-	-			VCCIO2	2		
T24	NC	-			PR38A	2		T
N34	NC	-			PR37B	2		C (LVDS)*
N33	NC	-			PR37A	2		T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		
M34	PR31B	2	RDQ28	C	PR35B	2	RDQ32	C
M33	PR31A	2	RDQ28	T	PR35A	2	RDQ32	T
-	-	-			GNDIO2	-		
R24	PR30B	2	RDQ28	C (LVDS)*	PR34B	2	RDQ32	C (LVDS)*
P24	PR30A	2	RDQ28	T (LVDS)*	PR34A	2	RDQ32	T (LVDS)*
N30	PR29B	2	RDQ28	C	PR33B	2	RDQ32	C
M29	PR29A	2	RDQ28	T	PR33A	2	RDQ32	T
VCCIO	VCCIO2	2			VCCIO2	2		
N28	PR28B	2	RDQ28	C (LVDS)*	PR32B	2	RDQ32	C (LVDS)*
N29	PR28A	2	RDQS28	T (LVDS)*	PR32A	2	RDQS32	T (LVDS)*
N24	PR27B	2	RDQ28	C	PR31B	2	RDQ32	C
GNDIO	GNDIO2	-			GNDIO2	-		
N25	PR27A	2	RDQ28	T	PR31A	2	RDQ32	T
M28	PR26B	2	RDQ28	C (LVDS)*	PR30B	2	RDQ32	C (LVDS)*
M27	PR26A	2	RDQ28	T (LVDS)*	PR30A	2	RDQ32	T (LVDS)*
L27	PR25B	2	RDQ28	C	PR29B	2	RDQ32	C
VCCIO	VCCIO2	2			VCCIO2	2		
M26	PR25A	2	RDQ28	T	PR29A	2	RDQ32	T
M32	PR24B	2	RDQ28	C (LVDS)*	PR28B	2	RDQ32	C (LVDS)*
M31	PR24A	2	RDQ28	T (LVDS)*	PR28A	2	RDQ32	T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		
-	-	-			VCCIO2	2		
L34	PR22B	2		C	PR22B	2	RDQ23	C
L33	PR22A	2		T	PR22A	2	RDQ23	T
L32	PR21B	2		C (LVDS)*	PR21B	2	RDQ23	C (LVDS)*
L31	PR21A	2		T (LVDS)*	PR21A	2	RDQ23	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
L28	PR20B	2		C	PR20B	2	RDQ23	C
L29	PR20A	2		T	PR20A	2	RDQ23	T
M30	PR19B	2		C (LVDS)*	PR19B	2	RDQ23	C (LVDS)*
L30	PR19A	2		T (LVDS)*	PR19A	2	RDQ23	T (LVDS)*
K34	PR18B	2	RDQ15	C	PR18B	2	RDQ15	C
K33	PR18A	2	RDQ15	T	PR18A	2	RDQ15	T
GNDIO	GNDIO2	-			GNDIO2	-		
K30	PR17B	2	RDQ15	C (LVDS)*	PR17B	2	RDQ15	C (LVDS)*
K29	PR17A	2	RDQ15	T (LVDS)*	PR17A	2	RDQ15	T (LVDS)*
J34	PR16B	2	RDQ15	C	PR16B	2	RDQ15	C
J33	PR16A	2	RDQ15	T	PR16A	2	RDQ15	T
VCCIO	VCCIO2	2			VCCIO2	2		
J32	PR15B	2	RDQ15	C (LVDS)*	PR15B	2	RDQ15	C (LVDS)*
J31	PR15A	2	RDQS15	T (LVDS)*	PR15A	2	RDQS15	T (LVDS)*

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2-35E-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2-35E-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2-35E-5FN672C	450	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2-35E-6FN672C	450	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2-35E-7FN672C	450	1.2V	-7	Lead-Free fpBGA	672	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5FN484C	339	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2-50E-6FN484C	339	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2-50E-7FN484C	339	1.2V	-7	Lead-Free fpBGA	484	COM	50
LFE2-50E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2-50E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2-50E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	70
LFE2-70E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	70
LFE2-70E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	70
LFE2-70E-5FN900C	583	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2-70E-6FN900C	583	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2-70E-7FN900C	583	1.2V	-7	Lead-Free fpBGA	900	COM	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5TN144I	90	1.2V	-5	Lead-Free TQFP	144	IND	6
LFE2-6E-6TN144I	90	1.2V	-6	Lead-Free TQFP	144	IND	6
LFE2-6E-5FN256I	190	1.2V	-5	Lead-Free fpBGA	256	IND	6
LFE2-6E-6FN256I	190	1.2V	-6	Lead-Free fpBGA	256	IND	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5TN144I	93	1.2V	-5	Lead-Free TQFP	144	IND	12
LFE2-12E-6TN144I	93	1.2V	-6	Lead-Free TQFP	144	IND	12
LFE2-12E-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	IND	12
LFE2-12E-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	IND	12
LFE2-12E-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	IND	12
LFE2-12E-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	IND	12
LFE2-12E-5FN484I	297	1.2V	-5	Lead-Free fpBGA	484	IND	12
LFE2-12E-6FN484I	297	1.2V	-6	Lead-Free fpBGA	484	IND	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5F484C	331	1.2V	-5	fpBGA	484	Com	35
LFE2-35SE-6F484C	331	1.2V	-6	fpBGA	484	Com	35
LFE2-35SE-7F484C	331	1.2V	-7	fpBGA	484	Com	35
LFE2-35SE-5F672C	450	1.2V	-5	fpBGA	672	Com	35
LFE2-35SE-6F672C	450	1.2V	-6	fpBGA	672	Com	35
LFE2-35SE-7F672C	450	1.2V	-7	fpBGA	672	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5F484C	339	1.2V	-5	fpBGA	484	Com	50
LFE2-50SE-6F484C	339	1.2V	-6	fpBGA	484	Com	50
LFE2-50SE-7F484C	339	1.2V	-7	fpBGA	484	Com	50
LFE2-50SE-5F672C	500	1.2V	-5	fpBGA	672	Com	50
LFE2-50SE-6F672C	500	1.2V	-6	fpBGA	672	Com	50
LFE2-50SE-7F672C	500	1.2V	-7	fpBGA	672	Com	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5F672C	500	1.2V	-5	fpBGA	672	Com	70
LFE2-70SE-6F672C	500	1.2V	-6	fpBGA	672	Com	70
LFE2-70SE-7F672C	500	1.2V	-7	fpBGA	672	Com	70
LFE2-70SE-5F900C	583	1.2V	-5	fpBGA	900	Com	70
LFE2-70SE-6F900C	583	1.2V	-6	fpBGA	900	Com	70
LFE2-70SE-7F900C	583	1.2V	-7	fpBGA	900	Com	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6SE-5T144I	90	1.2V	-5	TQFP	144	Ind	6
LFE2-6SE-6T144I	90	1.2V	-6	TQFP	144	Ind	6
LFE2-6SE-5F256I	190	1.2V	-5	fpBGA	256	Ind	6
LFE2-6SE-6F256I	190	1.2V	-6	fpBGA	256	Ind	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12SE-5T144I	93	1.2V	-5	TQFP	144	Ind	12
LFE2-12SE-6T144I	93	1.2V	-6	TQFP	144	Ind	12
LFE2-12SE-5Q208I	131	1.2V	-5	PQFP	208	Ind	12
LFE2-12SE-6Q208I	131	1.2V	-6	PQFP	208	Ind	12
LFE2-12SE-5F256I	193	1.2V	-5	fpBGA	256	Ind	12
LFE2-12SE-6F256I	193	1.2V	-6	fpBGA	256	Ind	12
LFE2-12SE-5F484I	297	1.2V	-5	fpBGA	484	Ind	12
LFE2-12SE-6F484I	297	1.2V	-6	fpBGA	484	Ind	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	100
LFE2M100SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	100
LFE2M100SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	100

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For Further Information

A variety of technical notes for the LatticeECP2/M family are available on the Lattice web site at www.latticesemi.com.

- TN1102, LatticeECP2/M sysIO Usage Guide
- TN1103, LatticeECP2/M sysCLOCK PLL Design and Usage Guide
- TN1104, LatticeECP2/M Memory Usage Guide
- TN1105, LatticeECP2/M High-Speed I/O Interface
- TN1106, Power Estimation and Management for LatticeECP2/M Devices
- TN1107, LatticeECP2/M sysDSP Usage Guide
- TN1108, LatticeECP2/M sysCONFIG Usage Guide
- TN1109, LatticeECP2/M Configuration Encryption Usage Guide
- TN1113, LatticeECP2/M Soft Error Detection (SED) Usage Guide
- TN1124, LatticeECP2M SERDES/PCS Usage Guide
- TN1162, LatticeECP2/M Hardware Checklist

For further information about interface standards refer to the following web sites:

- JEDEC Standards (LVTTL, LVCMOS, SSTL, HSTL): www.jedec.org
- PCI: www.pcisig.com